



**FAST CMOS
20-BIT
TRANSPARENT LATCH**

IDT54/74FCT16841AT/BT/CT/ET

FEATURES:

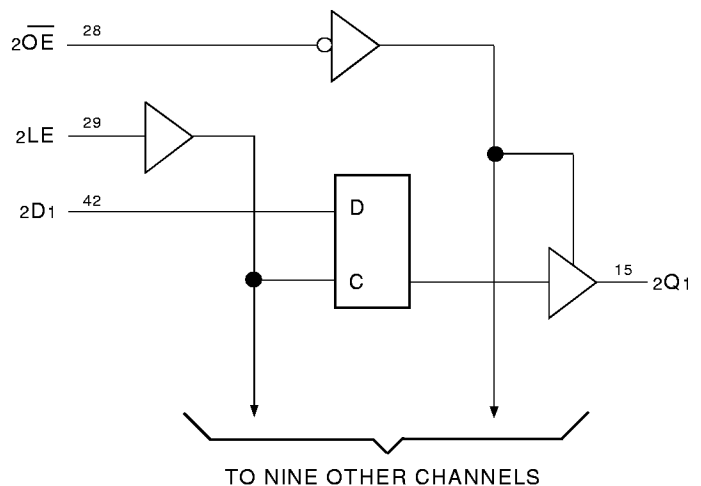
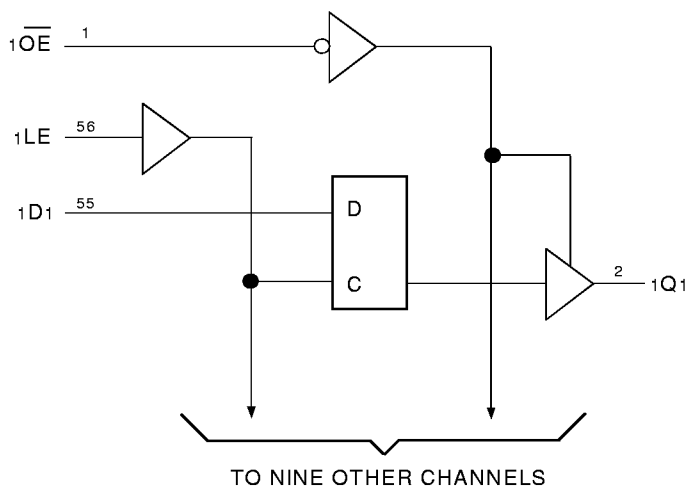
- 0.5 MICRON CMOS Technology
- High-speed, low-power CMOS replacement for ABT functions
- Typical tsk(o) (Output Skew) < 250ps
- Low input and output leakage $\leq 1\mu\text{A}$ (max.)
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- 25 mil pitch SSOP, 19.6 mil pitch TSSOP, 15.7 mil pitch TVSOP and 25 mil pitch CERPACK packages
- Extended commercial range of -40°C to +85°C
- Vcc = 5V $\pm 10\%$
- High drive outputs (-32mA IOH, 64mA IOL)
- Power off disable outputs permit "live insertion"
- Typical VOLP (Output Ground Bounce) < 1.0V at Vcc = 5V, TA = 25°C

DESCRIPTION:

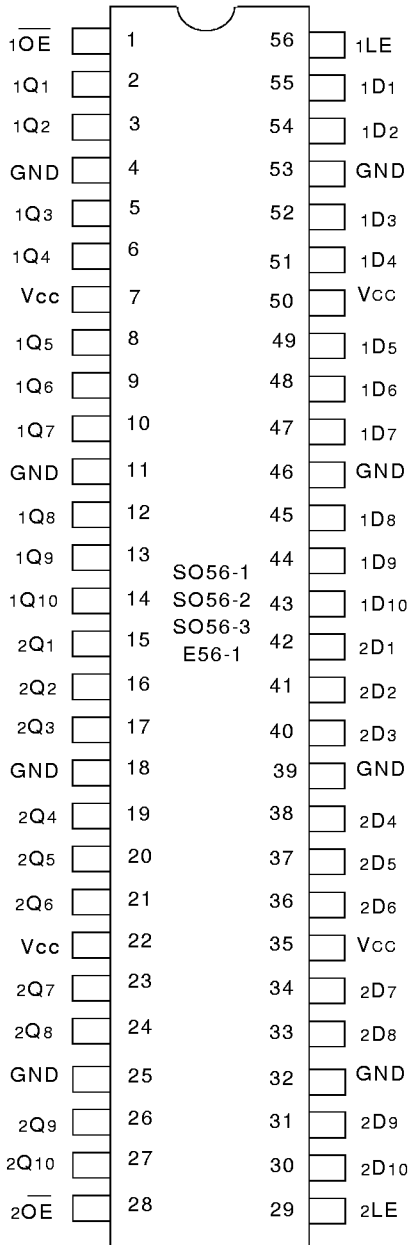
The FCT16841AT/BT/CT/ET 20-bit transparent D-type latches are built using advanced dual metal CMOS technology. These high-speed, low-power latches are ideal for temporary data storage. They can be used for implementing memory address latches, I/O ports, and bus drivers. The Output Enable ($\overline{\text{OE}}$) and Latch Enable (LE) controls are organized to operate each device as two 10-bit latches or one 20-bit latch. Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

The FCT16841AT/BT/CT/ET is ideally suited for driving high capacitance loads and low impedance backplanes. The output buffers are designed with power off disable capability to allow "live insertion" of boards when used as backplane drivers.

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION



SSOP/ TSSOP/ TVSOP/ CERPACK
TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
V _{TERM} ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7	V
V _{TERM} ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to V _{CC} +0.5	V
T _{STG}	Storage Temperature	-65 to +150	°C
I _{OUT}	DC Output Current	-60 to +120	mA

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NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- All device terminals except FCT162XXXT Output and I/O terminals.
- Output and I/O terminals for FCT162XXXT.

CAPACITANCE (T_A = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	3.5	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	3.5	8	pF

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NOTE:

- This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	Description
xD _x	Data Inputs
xLE	Latch Enable Input (Active HIGH)
x \overline{OE}	Output Enable Input (Active LOW)
xQ _x	3-State Outputs

FUNCTION TABLE⁽¹⁾

Inputs			Outputs
xD _x	xLE	x \overline{OE}	xQ _x
H	H	L	H
L	H	L	L
X	L	L	Q ⁽²⁾
X	X	H	Z

NOTES:

- H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
Z = High-Impedance
- Output Level before xLE HIGH-to-LOW transition.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Commercial: $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$; Military: $T_A = -55^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
V _{IH}	Input HIGH Level	Guaranteed Logic HIGH Level		2	—	—	V
V _{IL}	Input LOW Level	Guaranteed Logic LOW Level		—	—	0.8	V
I _{IH}	Input HIGH Current (Input pins) ⁽⁵⁾	V _{CC} = Max.	V _I = V _{CC}	—	—	±1	μA
	Input HIGH Current (I/O pins) ⁽⁵⁾			—	—	±1	
I _{IL}	Input LOW Current (Input pins) ⁽⁵⁾		V _I = GND	—	—	±1	
	Input LOW Current (I/O pins) ⁽⁵⁾			—	—	±1	
I _{OZH}	High Impedance Output Current (3-State Output pins) ⁽⁵⁾	V _{CC} = Max.	V _O = 2.7V	—	—	±1	μA
I _{OZL}			V _O = 0.5V	—	—	±1	
V _{IK}	Clamp Diode Voltage	V _{CC} = Min., I _{IN} = -18mA		—	-0.7	-1.2	V
I _{OS}	Short Circuit Current	V _{CC} = Max., V _O = GND ⁽³⁾		-80	-140	-250	mA
V _H	Input Hysteresis	—		—	100	—	mV
I _{CC1} I _{CC2} I _{CC3}	Quiescent Power Supply Current	V _{CC} = Max. V _{IN} = GND or V _{CC}		—	5	500	μA

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OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
I _O	Output Drive Current	V _{CC} = Max., V _O = 2.5V ⁽³⁾		-50	—	-180	mA
V _{OH}	Output HIGH Voltage	V _{CC} = Min. V _{IN} = V _{IH} or V _{IL}	I _{OH} = -3mA	2.5	3.5	—	V
			I _{OH} = -12mA MIL.	2.4	3.5	—	V
			I _{OH} = -15mA COM'L.	—	—	—	—
			I _{OH} = -24mA MIL. I _{OH} = -32mA COM'L. ⁽⁴⁾	2	3	—	V
V _{OL}	Output LOW Voltage	V _{CC} = Min. V _{IN} = V _{IH} or V _{IL}	I _{OH} = 48mA MIL. I _{OH} = 64mA COM'L	—	0.2	0.55	V
I _{OFF}	Input/Output Power Off Leakage ⁽⁵⁾	V _{CC} = 0V, V _{IN} or V _O ≤ 4.5V		—	—	±1	μA

NOTES:

- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 5.0V, +25°C ambient.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- Duration of the condition can not exceed one second.
- The test limit for this parameter is ±5μA at T_A = -55°C.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
ΔI_{CC}	Quiescent Power Supply Current TTL Inputs HIGH	V _{CC} = Max. V _{IN} = 3.4V ⁽³⁾		—	0.5	1.5	mA
I _{CCD}	Dynamic Power Supply Current ⁽⁴⁾	V _{CC} = Max. Outputs Open \overline{xOE} = GND One Input Toggling 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND	—	60	100	μA/ MHz
I _C	Total Power Supply Current ⁽⁶⁾	V _{CC} = Max. Outputs Open f _i = 10MHz 50% Duty Cycle \overline{xOE} = GND xLE = V _{CC} One Bit Toggling	V _{IN} = V _{CC} V _{IN} = GND	—	0.6	1.5	mA
			V _{IN} = 3.4V V _{IN} = GND	—	0.9	2.3	
		V _{CC} = Max. Outputs Open f _i = 2.5MHz 50% Duty Cycle \overline{xOE} = GND xLE = V _{CC} Twenty Bits Toggling	V _{IN} = V _{CC} V _{IN} = GND	—	3	5.5 ⁽⁵⁾	
			V _{IN} = 3.4V V _{IN} = GND	—	8	20.5 ⁽⁵⁾	

NOTES:

- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 5.0V, +25°C ambient.
- Per TTL driven input (V_{IN} = 3.4V). All other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
- I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}
 $I_C = I_{CC} + \Delta I_{CC} \cdot D_{HNT} + I_{CCD} \cdot (f_{CP} \cdot N_{CP} / 2 + f_i \cdot N_i)$
 $I_{CC} = \text{Quiescent Current (I}_{CCL}, I_{CCH} \text{ and } I_{CCZ})$
 $\Delta I_{CC} = \text{Power Supply Current for a TTL High Input (V}_{IN} = 3.4V)$
 $D_H = \text{Duty Cycle for TTL Inputs High}$
 $N_T = \text{Number of TTL Inputs at } D_H$
 $I_{CCD} = \text{Dynamic Current Caused by an Input Transition Pair (HLH or LHL)}$
 $f_{CP} = \text{Clock Frequency for Register Devices (Zero for Non-Register Devices)}$
 $N_{CP} = \text{Number of Clock Inputs at } f_{CP}$
 $f_i = \text{Input Frequency}$
 $N_i = \text{Number of Inputs at } f_i$

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Symbol	Parameter	Condition ⁽¹⁾	FCT16841AT				FCT16841BT				Unit
			Com'l.		Mil.		Com'l.		Mil.		
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	
t _{PLH} t _{PHL}	Propagation Delay xDx to xQx (LE = HIGH)	CL = 50pF RL = 500Ω	1.5	9	1.5	10	1.5	6.5	1.5	7.5	ns
		CL = 300pF ⁽⁵⁾ RL = 500Ω	1.5	13	1.5	15	1.5	13	1.5	15	
t _{PLH} t _{PHL}	Propagation Delay xLE to xQx	CL = 50pF RL = 500Ω	1.5	12	1.5	13	1.5	8	1.5	10.5	ns
		CL = 300pF ⁽⁵⁾ RL = 500Ω	1.5	16	1.5	20	1.5	15.5	1.5	18	
t _{PZH} t _{PZL}	Output Enable Time xOE to xQx	CL = 50pF RL = 500Ω	1.5	11.5	1.5	13	1.5	8	1.5	8.5	ns
		CL = 300pF ⁽⁵⁾ RL = 500Ω	1.5	23	1.5	25	1.5	14	1.5	15	
t _{PHZ} t _{PLZ}	Output Disable Time xOE to xQx	CL = 5pF ⁽⁵⁾ RL = 500Ω	1.5	7	1.5	9	1.5	6	1.5	6.5	ns
		CL = 50pF RL = 500Ω	1.5	8	1.5	10	1.5	7	1.5	7.5	
t _{SU}	Set-Up Time HIGH or LOW, xDx to xLE	CL = 50pF RL = 500Ω	2.5	—	2.5	—	2.5	—	2.5	—	ns
t _H	Hold Time HIGH or LOW, xDx to xLE		2.5	—	3	—	2.5	—	2.5	—	ns
t _w	xLE Pulse Width HIGH		4 ⁽⁴⁾	—	5	—	4 ⁽⁴⁾	—	4 ⁽⁴⁾	—	ns
t _{SK(o)}	Output Skew ⁽³⁾		—	0.5	—	0.5	—	0.5	—	0.5	ns

NOTES:

1. See test circuit and waveforms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
4. This limit is guaranteed but not tested.
5. This condition is guaranteed but not tested.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

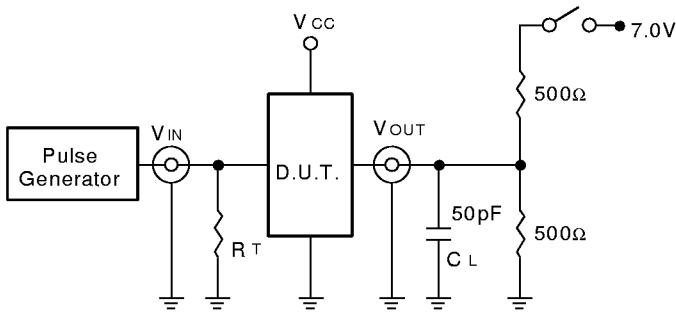
Symbol	Parameter	Condition ⁽¹⁾	FCT16841CT				FCT16841ET				Unit
			Com'l.		Mil.		Com'l.		Mil.		
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	
t _{PLH} t _{PHL}	Propagation Delay xDx to xQx (LE = HIGH)	CL = 50pF RL = 500Ω	1.5	5.5	1.5	6.3	1.5	3.4	—	—	ns
		CL = 300pF ⁽⁵⁾ RL = 500Ω	1.5	13	1.5	15	1.5	7.5	—	—	
t _{PLH} t _{PHL}	Propagation Delay xLE to xQx	CL = 50pF RL = 500Ω	1.5	6.4	1.5	6.8	1.5	3.7	—	—	ns
		CL = 300pF ⁽⁵⁾ RL = 500Ω	1.5	15	1.5	16	1.5	7.5	—	—	
t _{PZH} t _{PZL}	Output Enable Time xOE to xQx	CL = 50pF RL = 500Ω	1.5	6.5	1.5	7.3	1.5	4.4	—	—	ns
		CL = 300pF ⁽⁵⁾ RL = 500Ω	1.5	12	1.5	13	1.5	9	—	—	
t _{PHZ} t _{PLZ}	Output Disable Time xOE to xQx	CL = 5pF ⁽⁵⁾ RL = 500Ω	1.5	5.7	1.5	6	1.5	3.6	—	—	ns
		CL = 50pF RL = 500Ω	1.5	6	1.5	6.3	1.5	3.6	—	—	
tsu	Set-Up Time HIGH or LOW, xDx to xLE	CL = 50pF RL = 500Ω	2.5	—	2.5	—	1	—	—	—	ns
tH	Hold Time HIGH or LOW, xDx to xLE		2.5	—	2.5	—	1	—	—	—	ns
tw	xLE Pulse Width HIGH		4 ⁽⁴⁾	—	4 ⁽⁴⁾	—	3 ⁽⁴⁾	—	—	—	ns
tsk(o)	Output Skew ⁽³⁾		—	0.5	—	0.5	—	0.5	—	—	ns

NOTES:

1. See test circuit and waveforms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
4. This limit is guaranteed but not tested.
5. This condition is guaranteed but not tested.

TEST CIRCUITS AND WAVEFORMS

TEST CIRCUITS FOR ALL OUTPUTS



SWITCH POSITION

Test	Switch
Open Drain	Closed
Disable Low	
Enable Low	
All Other Tests	Open

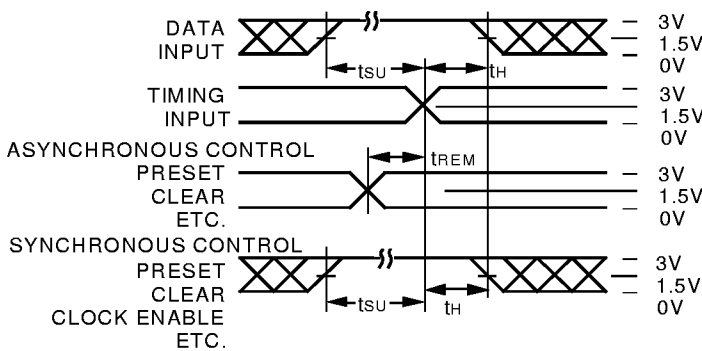
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DEFINITIONS:

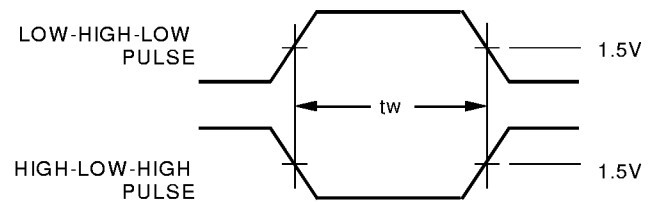
CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

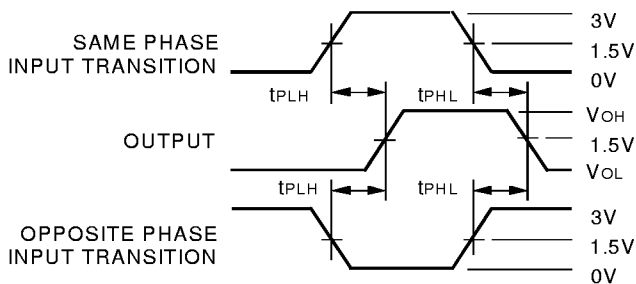
SET-UP, HOLD, AND RELEASE TIMES



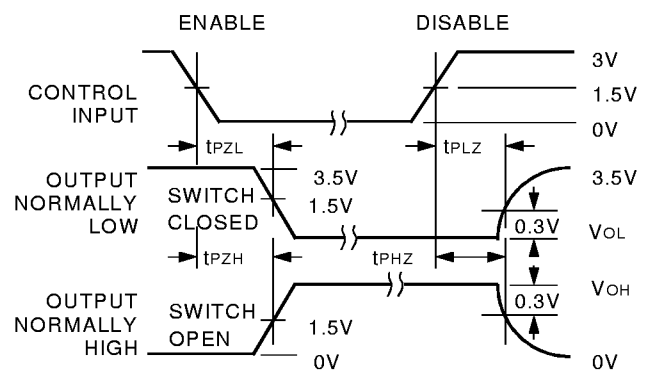
PULSE WIDTH



PROPAGATION DELAY



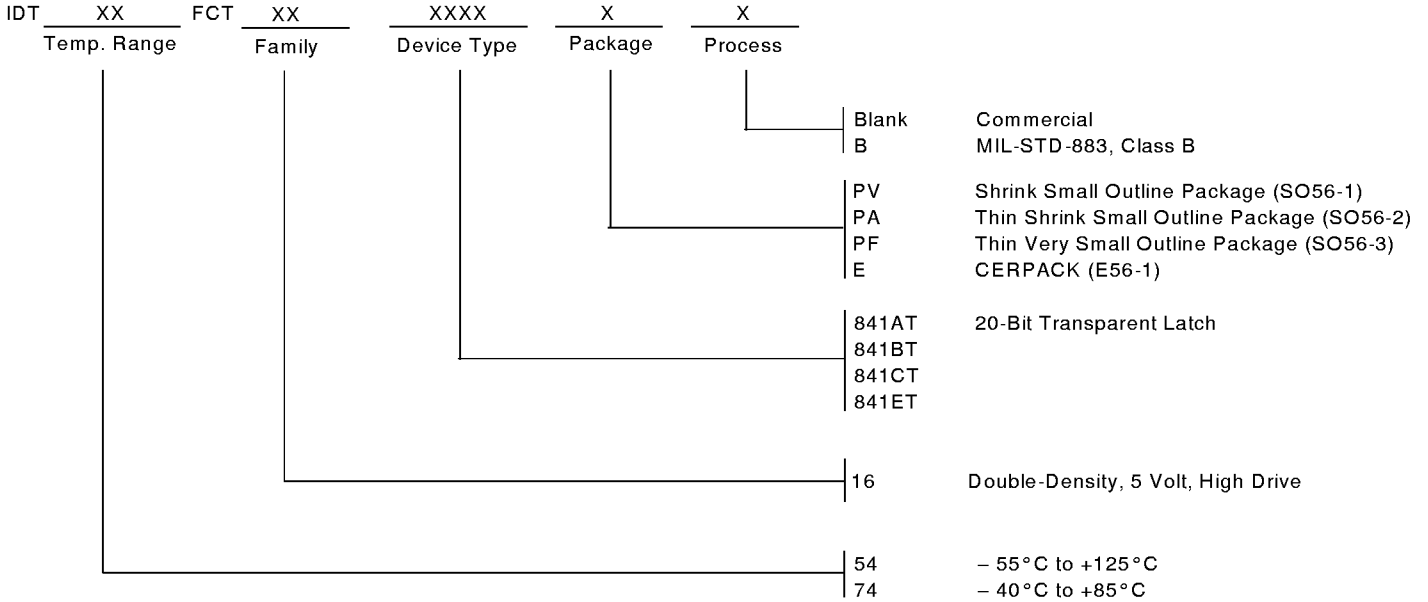
ENABLE AND DISABLE TIMES



NOTES:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
2. Pulse Generator for All Pulses: Rate $\leq 1.0\text{MHz}$; $t_f \leq 2.5\text{ns}$; $t_r \leq 2.5\text{ns}$.

ORDERING INFORMATION



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